Shuttle®

BAREBONE
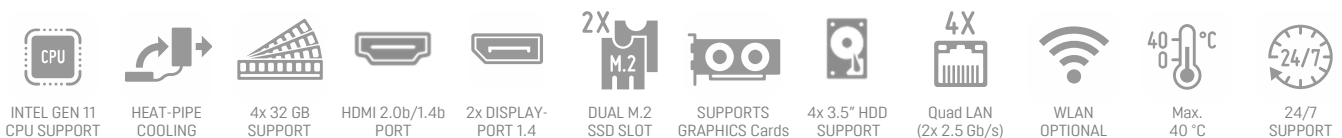## XPC cube
SW580R8

14-LITER CUBE FOR SERVER AND WORKSTATION APPLICATIONS

Like its sister model SH570R8, the Shuttle XPC Barebone SW580R8 supports 10th/11th generation Intel Core processors, four large 3.5" hard disks with Raid function, 128 GB DDR4-3200 RAM and dual-slot graphics cards. In addition, the SW580R8 also accepts Xeon W-series processors featuring ECC and vPro for more system stability and remote management options. It also offers four network ports for the first time (two of them with 2.5 GBit/s), a second M.2 slot for SSD cards and a TPM security chip. Such impressive performance and range of features in an aluminum chassis with a volume of only 14 liters makes SW580R8 the ideal platform for demanding mini-server and workstation PCs with top reliability even under heavy load.

| INTEL GEN 11 CPU SUPPORT | HEAT-PIPE COOLING | 4x 32 GB SUPPORT | HDMI 2.0b/1.4b PORT | 2x DISPLAY-PORT 1.4 | 2x DUAL M.2 SSD SLOT | SUPPORTS GRAPHICS Cards | 4x 3.5" HDD SUPPORT | 4X Quad LAN (2x 2.5 Gb/s) | WLAN OPTIONAL | Max. 40 °C | 24/7 SUPPORT |

CUBE DESIGN
■ Black aluminium chassis ■ Dimensions: 33.2 x 21.5 x 19 cm (LWH), ca. 13.6-litre ■ Operating temperature: 0~40 °C (non-condensing)

OPERATING SYSTEM
■ An operating system is not included
■ Supports Windows 10/11 and Linux (64-bit)

PROCESSOR SUPPORT
■ Socket LGA1200 supports Intel Xeon W series processors and Intel Core i9/i7/i5/i3, Pentium Gold and Celeron processors of Gen. 10 "Comet Lake" and Gen. 11 "Rocket Lake" with up to 125W TDP ■ Includes heatpipe cooling system

CHIPSET & GRAPHICS
■ Intel W580 Chipset ■ Supports Intel vPro/AMT with appropriate software and processors ■ Integrated Intel UHD graphics with triple 4K display support (Note: "F"-series Core CPUs lack the integrated graphics)

MEMORY SUPPORT
■ Four 288-pin DIMM slots ■ Supports up to 128 GB capacity in total (max. 32 GB each module) ■ Supports DDR4-2666/2933/3200
■ Supports ECC memory in conjunction with Intel Xeon processors

PCI-EXPRESS SLOTS
■ 1x PCIe X16 v3/v4 slot supports dual-slot graphics cards up to ca. 28 x 12 x 4 cm (LWH), with 6-pin and 8-pin power connector
■ 1x PCIe X4 v3 slot (not usable with dual-slot graphics card)

STORAGE – SATA / M.2
■ Bays: 4x 3.5" (internal), onboard: 4x SATA ports (supports RAID)
■ 2x M.2-2280M slot (one supports PCIe x4 v3/v4 NVMe)
■ 1x M.2-2230E for optional WLAN (accessory: WLN-M)

CONNECTORS
■ HDMI 1.4b/2.0b ■ 2x DisplayPort 1.4 ■ 4x USB 3.2 Gen2 ■ 4x USB 3.2 Gen1 (1x Type-C) ■ 4x USB 2.0 ■ 1x internal USB 2.0 ■ 4x RJ45 LAN Ports (2x Intel Gigabit and 2x Realtek 2.5G) ■ 5x Audio I/O (2x front, 3x rear) ■ Connector for external power button

POWER SUPPLY
■ Internal 500W power supply, 80Plus Gold

OPTIONAL ACCESSORIES
■ WLAN Kit (WLN-M (ac)/WLN-M1 (ax)) ■ RS232 COM Port (H-RS232) ■ Adapter for two 2.5" drives (PHD3) ■ 850W Power Supply (PC850)
■ Cable for external power button (CXP01)

Note: Some features marked in red color are only supported in combination with Gen 11 "Rocket Lake-S" processors.

Shuttle XPC cubes with Intel 5xx Chipset

| Product	CPU Socket	Xeon	Chip	Chassis	Drive bays	Intel LAN	vPro	ECC	Netzteil	UPC Code
SH510R4	LGA 1200	—	H510	R4	5.25" + 2x 3.5"	1x	—	—	300 W, 80+ Bronze	887993003948
SH570R6	LGA 1200	—	H570	R6	5.25" + 2x 3.5"	2x	—	—	300 W, 80+ Bronze	887993003498
SH570R6 Plus	LGA 1200	—	H570	R6	5.25" + 2x 3.5"	2x	—	—	500 W, 80+ Gold	887993003870
SH570R8	LGA 1200	—	H570	R8	4x 3.5"	2x	—	—	500 W, 80+ Gold	887993003504
SW580R8	LGA 1200	Yes	W580	R8	4x 3.5"	4x (2x 2.5G)	Yes	Yes	500 W, 80+ Gold	887993004174

REQUIRED COMPONENTS

The following components need to be added to make it a fully-configured Mini PC

Shuttle XPC Cube Barebone
SW580R8
(Photo without chassis cover)

LGA1200 Processor
Supports Intel Core i9 / i7 / i5 / i3, Pentium Gold or Celeron or Intel Xeon W series processors
Gen 10 "Comet Lake" or Gen 11 "Rocket Lake"
TDP max. 125 W
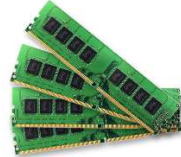
Memory Modules
Up to four 288-pin DIMM memory modules, max. 32 GB each
Supports DDR4-3200 clock rate with Gen 11 CPUs
Supports DDR4-2933/2666 clock rate with Gen 10 CPUs
Supports ECC memory modules with Intel Xeon processors

SATA Storage Drives
The drive rack supports four 3.5" drives.

Note: use accessory PHD3 to install two 2.5" drives (Hard disks or SSDs) in a 3.5" bay. The mainboard features four SATA ports and one USB 2.0 onboard header.

M.2 SSD (optional)
Supports M.2-2280/2260/2242 formats
Supports SATA or PCIe/NVMe interfaces
(in conjunction with a Gen 10 „Comet Lake" processor one of the two M.2 slot supports SATA mode only)
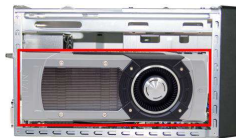
PCI-EXPRESS CARDS (optional)
1) PCI-E X16 slot (e.g. Single-Slot graphics card)
2) PCI-E X4 slot (e.g. Dual 10 Gb network card)
The power consumption of the graphics card must not exceed 300 watts [4]. Max. length is 280 mm. If a dual-slot (double-width) graphics cards is used the second PCI-Express slot will be occupied.
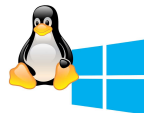
Operating System
Windows 10/11 or Linux (64-bit only)

OPTIONAL ACCESSORIES FROM SHUTTLE

WLAN-Accessory
WLN-M (802.11ac / Wifi 5)
WLN-M1 (802.11ax / Wifi 6)
M.2-2230 card supports WLAN and Bluetooth including 2 antennas

Adapter for 2.5" drives
PHD3
The PHD3 allows for installation of one or two 63.5 mm (2.5") hard drives or SSDs into a larger 89 mm (3.5") drive bay.

PSU Upgrade **PC850**
850W power supply upgrade kit with 80 PLUS® Platinum efficiency
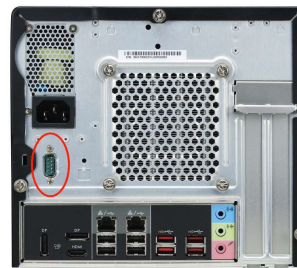
COM Port Adapter
H-RS232
The H-RS232 allows for installation of one serial COM port (RS232) in the back panel.

Cable **CXP01**
Cable for external push button switch (without button)

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PRODUCT FEATURES

The R8 chassis design: stylish and sophisticated

The R8 is the case design of choice when it comes to flexible storage solutions thanks to its four-hard-drive support. At the same time it provides an incredible amount of space for large state-of-the-art graphics cards. The R8 case uses light aluminium as its stylish base material and the brushed surfaces are truly eye-catching.

Integrated Cooling Engine

In order to ensure proper airflow inside such a small case, more advanced cooling technologies have been developed and implemented in the Shuttle XPC. Shuttle's industry-leading I.C.E. heatpipe technology delivers efficient cooling and is exceptionally quiet.

What is a Barebone?

The SW580R8 consists of a stylish case with pre-installed mainboard, power supply unit (PSU) and cables. Despite its small form factor, it offers outstanding connectivity, functionality and performance. For a full PC system, a processor, memory, mass storage and operating system need to be added. Shuttle XPC cube Barebones are completely customisable meaning users can pick certain components on their own to ideally match their individual needs.

Supports Intel Xeon Processors and ECC memory

SW580R8 is equipped with the Intel® W580 workstation chipset that supports Intel® Xeon® W-1000 series processor and ECC memory, delivering reliable performance and enhanced security. ECC RAM modules use an error correction code (ECC) to detect and correct data corruption which may occur in memory. It is recommended for computers where data corruption cannot be tolerated under any circumstances, like industrial control applications or critical databases.

Supports Intel® vPro™ / AMT

Intel® vPro™ is a brand name for a specific set of management and security technologies. Intel® Active Management Technology (AMT) is a subset of Intel vPro. This technology allows remote management of PCs, even in power-off mode or with non-functional operating systems. You can audit, repair and restore AMT-based platforms in a LAN. These functions can increase the uptime of desktops with lower maintenance costs. Intel vPro requires appropriate software and processors.

Four Network Ports

SW580R8 adopts a couple of Intel 1GbE LAN and RealTek 2.5GbE LAN. Multi-LAN is usually targeted at the enterprise with a number of potential applications, e.g. failover/fallback (two networks if one network fails), redundancy/security (separate network for production/maintenance or private/public etc.

Ample space for demanding dual-slot graphics cards

Despite the small housing, the SW580R8 is capable of running dual-slot (double-height) high-performance PCI Express graphics cards. The system provides additional 6-pin and 8-pin power connectors for more power-hungry graphics cards. The maximum size acceptable for graphics cards is 280 mm x 120 mm x 38 mm. Please refer to the support list for detailed support information at global.shuttle.com.

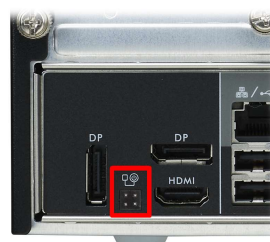### Triple UHD display support and more

The integrated graphics supports up to three independent monitors at Ultra-HD resolution if not an F-type CPU is used.
This XPC even supports at least five displays in combination with a discrete PCI-Express graphics card, based on the Switchable Graphics feature. Expand your Windows desktop across many monitors, but note it does not support a 2x2 configuration or clone mode with the monitors connected.

External power button by separate remote line

If, because of space constraints (e.g. in case of fixed installation), the machine cannot be switched on by pressing the front power button, it can be powered on by a separate remote line. You will find an appropriate four-pin connector at the back panel of the SW580R8 (pitch 2.54 mm). Furthermore, this connector provides a Clear CMOS function and +5V DC voltage supply for external devices.

+5V voltage (2)　　　　　(4) Power Button
Clear CMOS (1)　　　　　(3) Ground

Front and Back Panel

Front panel

1. Hard disk LED indicator
2. Power LED indicator
3. Power button
4. 3x USB 3.2 Gen 1 Type-A port (5 Gbps)
5. Microphone input
6. Headphones output
7. USB 3.2 Gen 1 Type-C port (5 Gbps)

Back panel
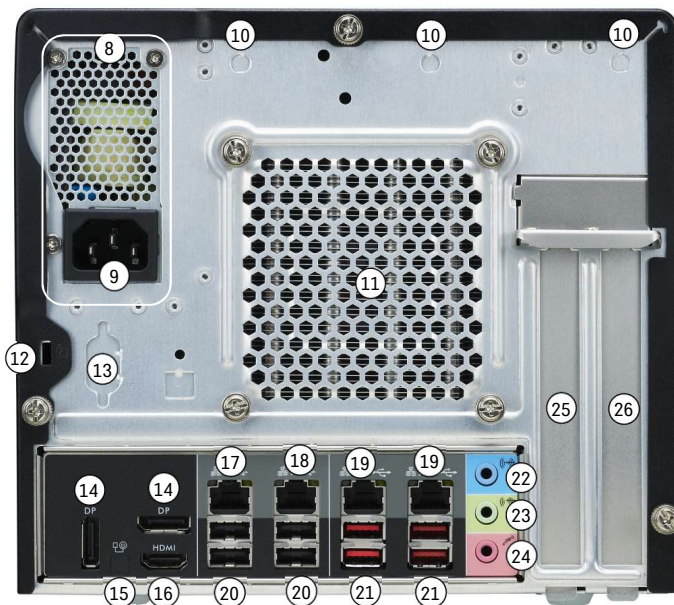
8. Internal power supply unit (PSU)
9. AC power connector
10. 3x perforation for optional WLAN antenna
11. Heat-pipe cooling system
12. Hole for Kensington Lock
13. Perforation for optional COM port
14. DisplayPort 1.4
15. 4-pin connector (2.54 mm pitch) for external power button, Clear CMOS button and 5V DC voltage
16. HDMI 2.0b/1.4b
17. Gigabit LAN port (Intel i210AT)
18. Gigabit LAN port (Intel i219LM) supports Intel vPro/AMT
19. 2x 2.5G LAN port (Realtek 8125b)
20. 4x USB 2.0 port
21. 4x USB 3.2 Gen 2 Type-A port (10 Gbps)
22. Audio Line-in
23. Audio Line-out
24. Microphone input
25. PCI-Express X16 expansion slot
26. PCI-Express X4 expansion slot

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Mainboard

Back panel
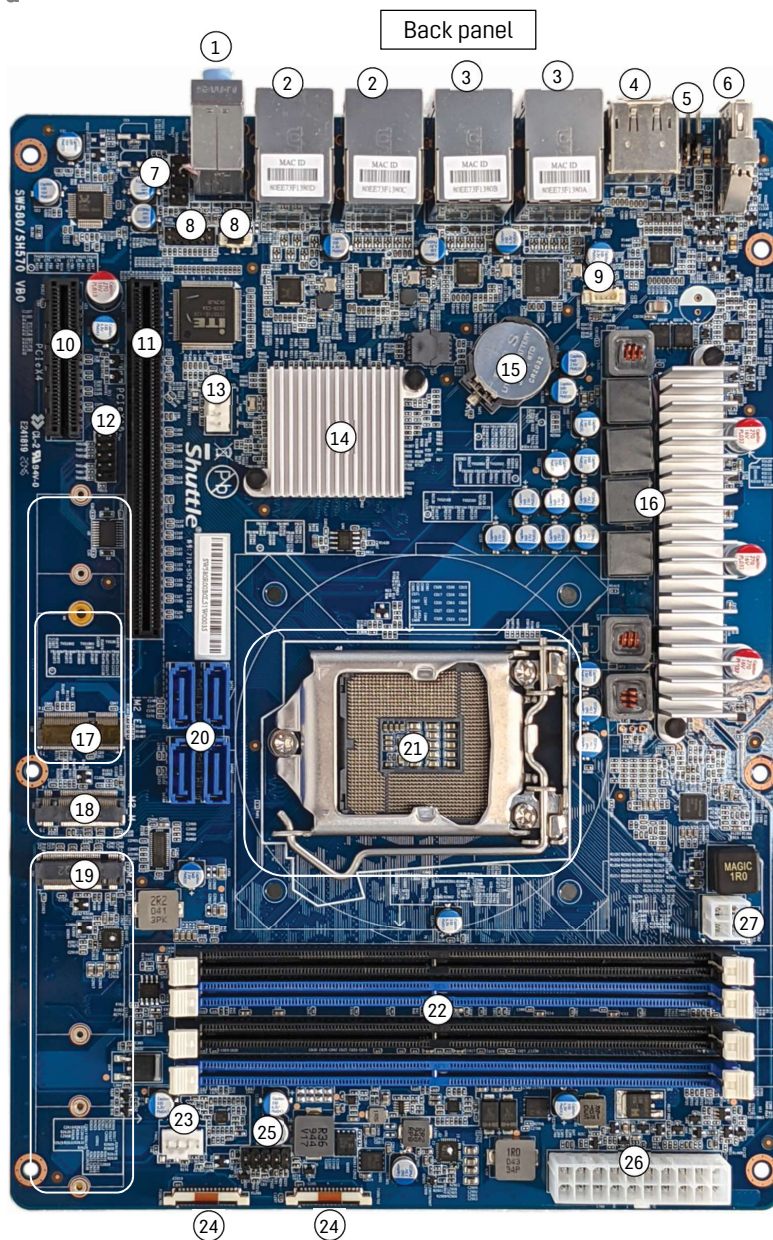
1. 3x Audio Ports (Line-in / Line-out / Microphone)
2. 2x RJ45 2.5G LAN port and
   4x USB 3.2 Gen 2 Type-A Port (10 Gbps)
3. 2x RJ45 Gigabit LAN port and
   4x USB 2.0 port
4. HDMI 2.0b/1.4b port & DisplayPort 1.4
5. 4-pin connector (2.54 mm pitch) for external power button,
   Clear CMOS button and 5V DC voltage
6. DisplayPort 1.4
7. Front audio header
8. Debug header (reserved)
9. Onboard USB 2.0 connector (4-pin)
10. PCI-Express X4 expansion slot
11. PCI-Express X16 expansion slot
12. Onboard RS232 COM port header (2x5-pin)
13. Connector for cooling fan (4-pin)
14. Intel H580 chipset with heat sink
15. CMOS battery
16. CPU voltage regulator area
17. M2-2230E slot for WLAN card
18. M.2-2280M slot for SSD card
19. M.2-2280M slot for SSD card
20. 4x SATA v3.0 connector
21. LGA1200 processor socket
22. 4x DIMM memory slot
23. Connector for cooling fan (4-pin)
24. Front USB 3.0 header
25. Front buttons / LEDs header
26. ATX power connector (20-pin)
27. ATX power connector (4-pin)

Shuttle Product Comparison: SH3xx versus SH5xx

The differences in the newer SH5xx series are marked in red.

MODEL	SH310R4V2	SH370R6V2 PLUS	SH370R8	SH510R4	SH570R6 PLUS	SH570R8	SW580R8
CHASSIS	R4 chassis customisable front plate	R6 chassis with front doors for I/O ports	R8 chassis supports four 3.5" hard disks	R4 chassis customisable front plate	R6 chassis with front doors for I/O ports	R8 chassis supports four 3.5" hard disks	R8 chassis supports four 3.5" hard disks
PROCESSOR SUPPORT	Socket LGA1151v2, TDP max. 95 W Code name "Coffee Lake-S" 14 nm – Gen 8 and 9 Supports Celeron, Pentium Gold, Core i3 / i5 / i7 / i9			Socket LGA1200, TDP max. 125 W Code name "Comet/Rocket Lake-S" 14 nm – Gen 10/11 Supports Celeron, Pentium Gold, Core i3 / i5 / i7 / i9			
XEON SUPPORT	—	—	—	—	—	—	Xeon W-Series
CPU COOLING	3 heat-pipes	3 heat-pipes	3 heat-pipes	4 heat-pipes	4 heat-pipes	4 heat-pipes	4 heat-pipes
CHIPSET	Intel H310	Intel H370	Intel H370	Intel H510	Intel H570	Intel H570	Intel W580
Intel vPRO/AMT	—	—	—	—	—	—	Supported
TPM 2.0	Firmware	Firmware	Firmware	Firmware	Firmware	Firmware	Hardware-Chip
OS SUPPORT	Windows 10/11 and Linux (64-bit)			Windows 10/11 and Linux (64-bit)			
DRIVE BAYS	1x 5.25" 2x 3.5"	1x 5.25" 2x 3.5" (1x open)	4x 3.5"	1x 5.25" 2x 3.5"	1x 5.25" 2x 3.5" (1x open)	4x 3.5"	4x 3.5"
SATA PORTS	3	4	4	3	4	4	4
PCI-E SLOTS	PCIe X16 v3.0 PCIe X1 V2.0	PCIe X16 v3.0 PCIe X4 V3.0	PCIe X16 v3.0 PCIe X4 V3.0	PCIe X16 v4.0 PCIe X1 V2.0	PCIe X16 v4.0 PCIe X4 V3.0	PCIe X16 v4.0 PCIe X4 V3.0	PCIe X16 v4.0 PCIe X4 V3.0
MAX. RAM SUPPORT	2x 16 GB DDR4-2933	4x 32 GB DDR4-2933	4x 32 GB DDR4-2933	2x 32 GB DDR4-3200 [*]	4x 32 GB DDR4-3200 [*]	4x 32 GB DDR4-3200 [*]	4x 32 GB DDR4-3200 [*] Supports ECC
GRAPHICS PORTS	HDMI 2.0a DP 1.2, VGA	HDMI 2.0a 2x DP 1.2	HDMI 2.0a 2x DP 1.2	HDMI 2.0b [*] DP 1.4, VGA	HDMI 2.0b [*] 2x DP 1.4	HDMI 2.0b [*] 2x DP 1.4	HDMI 2.0b [*] 2x DP 1.4
M.2 SSD SLOT	1	1	1	1	1	1	2
WLAN SLOT	M.2-2230E			M.2-2230E			
BUTTONS / LEDS	Power-Button, Power LED, HDD LED			Power-Button, Power LED, HDD LED			
USB 3.2 GEN 2	—	4	4	—	4	4	4
USB 3.2 GEN 1	4	4	4	4	4 (1x Type-C)	4 (1x Type-C)	4 (1x Type-C)
USB 2.0	4	4	4	4	4	4	4
USB 2.0 onboard	1	2	2	1	1	1	1
1G NETWORK	1x Intel i219LM	2x Intel 211	2x Intel 211	1x Intel i219LM	1x Intel i210AT 1x Intel i219LM	1x Intel i210AT 1x Intel i219LM	1x Intel i210AT 1x Intel i219LM
2.5G NETWORK	—	—	—	—	—	—	2x RTL 8125b
AUDIO	Mic-Input, Headphone Output and 6-channel Line-Out			Mic-Input, Headphone Output and 6-channel Line-Out			
OPTIONAL ACCESSORIES	WLAN Kit: **WLN-M** (ac) **/WLN-M1** (ax) COM-Port: **H-RS232** 3.5"/2.5" Adapter: **PHD3**			WLAN Kit: **WLN-M** (ac) **/WLN-M1** (ax) COM-Port: **H-RS232** 3.5"/2.5" Adapter: **PHD3** Cable for ext. power button: **CXP01** 850W-power supply: **PC850**			
POWER SUPPLY	300W 80+ Bronze	300W **Plus:** 500W	500 W 80+ Gold	300W 80+ Bronze	300W **Plus:** 500W	500 W 80+ Gold	500 W 80+ Gold

[*] Note: SH5xx-Series supports PCIe X16 **V4** slot, DDR4-**3200** and HDMI **2.0b** with **Gen. 11** Processors **"Rocket Lake"**, but only PCIe X16 **V3** slot, DDR4-**2666/2933** and HDMI **1.4b** with **Gen. 10** Processors **"Comet Lake"**.

PRODUCT SPECIFICATIONS

SHUTTLE XPC CUBE BAREBONE SW580R8 — SPECIFICATIONS

CHASSIS	Black aluminium chassis Front panel: brushed aluminium Front door for I/O ports (USB and Audio) Kensington Security Slot at the backpanel (also called K-Slot or Kensington lock) as a part of an anti-theft system Dimensions: 33.2 x 21,5 x 19.0 cm (LWH without feet) = 13.6 litre Height with rubber feet: 19.7 cm Weight: 3.5 kg net / 4.5 kg gross
MAINBOARD / CHIPSET	Mainboard with Shuttle form factor, proprietary design for XPC SW570R8 Chipset/Southbridge: Intel® W580 Passive chipset cooling with heat sink The Northbridge is integrated in the processor. Solid Capacitors for sensitive areas provide excellent heat resistance for enhanced system durability
BIOS	AMI BIOS, SPI Interface, 16 MB Flash-EEPROM Supports Hardware Monitoring, Watch Dog Supports Power Fail Resume Supports boot up from external USB flash memory Supports Unified Extensible Firmware Interface (UEFI)
SUPPORTS INTEL® vPRO™ AND AMT	Intel® vPro™ is a brand name for a specific set of management and security technologies. Intel® Active Management Technology (AMT) is a subset of Intel vPro. This technology allows remote management of PCs, even in power-off mode or with non-functional operating systems. You can audit, repair and restore AMT-based platforms in a LAN. These functions can increase the uptime of desktops with lower maintenance costs. Note: Intel vPro requires appropriate software and processors. The Intel® MEBX configuration user interface can be accessed after pressing CTRL-P at the beginning of the boot process. Only Intel Xeon or certain Core i5/i7/i9 processors support the Intel vPro® feature. Only the Intel i219 network chip supports the Intel vPro® function. Use the second LAN port from the left for this purpose.
TPM MODULE	Hardware Trusted Platform Module (Infineon SLB9670VQ2, TPM 2.0)
POWER SUPPLY	Built-in 500 Watt mini switching power supply [4] AC input voltage: 100~240V, 50~60 Hz 80 PLUS Gold compliant Active PFC circuit (Power Factor Correction) ATX main power connectors: 2x10 and 2x2-pin Graphics power connector: 6-pin and 8-pin Other connectors: 4x SATA, 2x Molex
OPERATING SYSTEM	This system comes without operating system. It is compatible with Windows 10/11 and Linux (64-bit)
PROCESSOR SUPPORT	Processor Socket LGA 1200 Supports Intel Core i9 / i7 / i5 / i3, Pentium Gold and Celeron processors Supports Intel Xeon W series processors (W12xx and W13xx series) Supports the 10th and 11th generation Intel Core processors, code name "Comet Lake" and "Rocket Lake" in 14++ nm process technology Maximum supported processor power consumption (TDP) = 125 W Up to 10 CPU cores, 20 threads and 20 MB of L3 cache Does not support the unlock-function of Intel K-Series processors. The processor integrates PCI-Express, memory controller and the graphics engine on the same die. However, processors with "F" identifier do not support integrated graphics [2] (performance features depending on processor type) Please refer to the support list for detailed processor support information at global.shuttle.com.
HEAT-PIPE COOLING	Shuttle I.C.E. (Integrated Cooling Engine) advanced I.C.E. heatpipe technology, linear-controlled 92mm fan SilentX cooling and noise reduction technology with Active Airflow

MEMORY SUPPORT	4x 288-pin slot Supports DDR4 memory at 1.2V Supports Dual Channel mode Supports max. 32 GB per DIMM, maximum total size of 128 GB The maximum DDR4 clock frequency depends on the processor type used: - Gen. 11 "Rocket Lake" supports DDR4-3200 (PC4-25600U) - Gen. 10 "Comet Lake" Core i7/i9 supports DDR4-2933 (PC4-23433U) - other Gen. 10 "Comet Lake" support DDR4-2666 (PC4-21300U) Supports unbuffered ECC memory in conjunction with Xeon processors
PCI-E EXPANSION SLOTS	1x PCI-Express x16 v4.0 slot (supports PCI-Express v3.0 with Gen. 10 "Comet Lake" processors) 1x PCI-Express x4 v3.0 slot, open-ended Supports dual-slot (double-width) graphics cards (occupies the second PCI-Express slot) The maximum size acceptable for display cards is 280 x 120 x 40 mm. Graphics power connector: 6-pin and 8-pin **[4]**
INTEGRATED GRAPHICS (OPTIONAL [2])	The features of the integrated Intel UHD graphics function depend on the processor type used. Certain processor models do not support integrated graphics **[2]** The PC features three video outputs which support 2160p/60 UHD resolution: - 1x HDMI v2.0b (only HDMI v1.4b with Gen. 10 "Comet Lake" Prozessoren) - 2x DisplayPort v1.4 Supports displays with 4K Ultra HD resolution at 3840 x 2160 (2160p/60) Supports three independent displays with the integrated graphics function Supports more displays in combination with a discrete graphics card Hardware video decoding/encoding DisplayPort and HDMI support multi-channel digital audio over the same cable
DRIVE BAYS	Storage bays: 4x 3.5" (internal) Using the optional accessory PHD3 two 2.5" drives can be installed into one 3.5" bay.
SATA CONNECTORS	4x Serial ATA 6G connector onboard (rev. 3.0, max. 6 Gbit/s) Supports Intel Rapid Storage Technology (RST) with RAID 0/1/5/10, JBOD
TWO M.2-2280M SSD SLOTS	Provides two internal M.2 2280 M slots für M.2 SSD cards Slot 1: supports PCIe Gen. 4.0 X4 with NVMe or SATA v3.0 (supports only SATA v3.0 with Gen. 10 "Comet Lake-S CPU) Slot 2: supports PCIe Gen. 3.0 X4 with NVMe or SATA v3.0 It supports M.2 cards with a width of 22 mm and a length of 42, 60 or 80 mm (type 2242, 2260, 2280).
M.2-2230E SLOT FOR WLAN CARDS	Interfaces: PCI-Express Gen. 3.0 X1 und USB 2.0 Supports M.2 cards with a width of 22 mm and a length of 30 mm (type 2230) Supports WLAN extension cards (optional Shuttle accessory: WLN-M)
HD AUDIO	Audio Codec: Realtek ALC897, 5.1 channel Three analog audio connectors (3.5 mm) on the backpanel: Line-in (blue), line-out (green) and microphone input (pink) shared with 5.1 channel line-out (front, rear, center/bass) Front panel: microphone input and head phone output (line-out)
FOUR NETWORK PORTS	Supports four RJ45 LAN ports for Ethernet networking Port 1+2: Intel 210AT / 219LM - supports 10 / 100 / 1.000 Mbps data transfer rate (the LED lights green/orange at 100M/1G speed) Port 3+4: Realtek 8125b - supports 10 / 100 / 1.000 / 2.500 Mbps data transfer rate (the LED lights green/orange at 1G/2.5G speed) Supports WAKE ON LAN (WOL) Supports network boot by Preboot eXecution Environment (PXE) Teaming mode is possible for port 1+2 and port 3+4 respectively **[3]**
FRONT PANEL CONNECTORS	Microphone input (3.5 mm) Headphones output (3.5 mm) 1x USB 3.2 Gen 1 (5 Gbps), Type C 3x USB 3.2 Gen 1 (5 Gbps), Type A, blue Power button Power indicator (Blue LED) Hard disk drive indicator (Yellow LED)

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BACK PANEL CONNECTORS	1x HDMI 2.0b (HDMI 1.4b with Gen. 10 "Comet Lake" processor) 2x DisplayPort 1.4 **[1]** 4x USB 3.2 Gen 2 (10 Gbps), Type A, red 4x USB 2.0 (Type A, black) 2x Gigabit LAN (RJ45) 2x 2.5G LAN (RJ45) Audio Line-out (3.5 mm) Audio Line-in (3.5 mm) Microphone Input (3.5 mm) 1x 4-pin connector (2.54 mm pitch) supports: - external power on button - Clear CMOS function - +5V DC voltage for external components Optional: Serial RS232 port (Accessory: "H-RS232") 3x perforation for optional WLAN antennas (Accessory: "WLN-M")
OTHER ONBOARD CONNECTORS	Occupied front panel connectors for USB, audio, buttons, LEDs 1x RS232 serial interface (2x5 pin header) 2x fan connectors (4-pin header) 1x USB 2.0 (4-pin header)
SUPPLIED ACCESSORIES	Multi-language XPC Installation Guide (EN, DE, FR, ES, JP, KR, SC, TC) Windows 64-bit driver disk 2x Serial ATA cables AC Power Cord (with protective-earth contacts) Heatsink Compound Protector cap for the CPU socket (do not use if heatpipe or fan is mounted) Bag with screws
OPTIONAL ACCESSORIES	Back panel adapter for serial RS232 port **(H-RS232)** WLAN kit supports WLAN and Bluetooth with two external antennas (**WLN-M** (802.11ac) and **WLN-M1** (802.11ax)) Adapter for 2.5" drives such as SSDs **(PHD3)** Adapter cable for external power button **(CXP01)** 850W power supply **(PC850)**
ENVIRONMENTAL SPECIFICATIONS	Permissible ambient temperature during operation: 0~40 °C Relative humidity: 10~90 %.
CERTIFICATIONS / COMPLIANCE	EMI: FCC, CE, BSMI, C-Tick Safety: ETL, CB, BSMI Other: RoHS, Energy Star 5.0, ErP This device is classed as a technical information equipment (ITE) in class B and is intended for use in living room and office. The CE-mark approves the conformity by the EU directives: (1) 2014/30/EU relating to electromagnetic compatibility (EMC), (2) 2014/35/EU relating to Electrical Equipment designed for use within certain voltage limits (LVD), (3) 2009/125/EC relating to ecodesign requirements for energy-related products (ErP).

[1] How to convert DisplayPort to HDMI/DVI
The DisplayPort output can be converted to HDMI or DVI by an additional, passive adapter cable. For example:
DELOCK 82590: 1 m, DisplayPort (male, 20p) to HDMI-A (male, 19p)
DELOCK 82435: 5 m, DisplayPort (male, 20p) to DVI-D (male, 24p)
The integrated graphics automatically detects the connected display and puts out the appropriate electric signal - either DisplayPort (without an adapter) or HDMI/DVI (with an adapter).
However, a monitor with a DisplayPort connector cannot be connected to the HDMI port with a simple, passive adapter.

[2] Integrated graphics is optional
Processors with model numbers ending with "F" (z.B. Intel Core i5-11600F) do not support integrated graphics, so that the graphics outputs of the Shuttle XPC have no function. In this case, an additional discrete PCIe graphics card is mandatory.

[3] Teaming Mode
The teaming function allows you to group both available network adapters together to function as a single adapter. The benefit of this approach is that it enables load balancing and failover.

[4] Online Power Calculator
The PCI Express x16 slot provides a maximum of 75 Watts to the graphics card, plus 75 Watts and 150 Watts from the 6-pin and 8-pin connector of the power supply - so the power consumption of the graphics card must not exceed 300 watts. The processor may have a maximum TDP of 125 Watts. If powerful PC components are used, then check with the "Power Supply Calculator" whether the built-in 500 Watt power supply supports this configuration, see: http://global.shuttle.com/support/power. Please also refer to the support list for detailed processor and graphics cards support information at http://global.shuttle.com.

10ᵀᴴ GENERATION INTEL CORE DESKTOP PROCESSOR FAMILY

Socket LGA1200 14 nm "Comet Lake S" and "Comet Lake Refresh" processor overview (Date: November 2021)

PROCESSOR	MODEL	CORES/ THREADS	CPU CLOCK	TURBO BOOST CLOCK (2.0)	SMART CACHE	TDP	MEMORY SUPPORT	vPRO/AMT SUPPORT	GRAPHICS ENGINE
Core™ i9	10900K	10/20	3.7 GHz	5.1 GHz	20 MB	125 W	DDR4-2933	–	UHD 630 (1.2 GHz)
	10900KF	10/20	3.7 GHz	5.1 GHz	20 MB	125 W	DDR4-2933	–	None
	10900	10/20	2.8 GHz	5.0 GHz	20 MB	65 W	DDR4-2933	–	UHD 630 (1.2 GHz)
	10900F	10/20	2.8 GHz	5.0 GHz	20 MB	65 W	DDR4-2933	–	None
	10900T	10/20	1.9 GHz	4.5 GHz	20 MB	35 W	DDR4-2933	–	UHD 630 (1.2 GHz)
	10850K	10/20	3.6 GHz	5.0 GHz	20 MB	125 W	DDR4-2933	–	UHD 630 (1.2 GHz)
Core™ i7	10700K	8/16	3.8 GHz	5.0 GHz	16 MB	125 W	DDR4-2933	Yes	UHD 630 (1.2 GHz)
	10700KF	8/16	3.8 GHz	5.0 GHz	16 MB	125 W	DDR4-2933	–	None
	10700	8/16	2.9 GHz	4.7 GHz	16 MB	65 W	DDR4-2933	Yes	UHD 630 (1.2 GHz)
	10700F	8/16	2.9 GHz	4.7 GHz	16 MB	65 W	DDR4-2933	–	None
	10700T	8/16	2.0 GHz	4.4 GHz	16 MB	35 W	DDR4-2933	Yes	UHD 630 (1.2 GHz)
Core™ i5	10600K	6/12	4.1 GHz	4.8 GHz	12 MB	125 W	DDR4-2666	Yes	UHD 630 (1.2 GHz)
	10600KF	6/12	4.1 GHz	4.8 GHz	12 MB	125 W	DDR4-2666	Yes	None
	10600	6/12	3.3 GHz	4.8 GHz	12 MB	65 W	DDR4-2666	–	UHD 630 (1.2 GHz)
	10600T	6/12	2.4 GHz	4.0 GHz	12 MB	35 W	DDR4-2666	Yes	UHD 630 (1.2 GHz)
	10505	6/12	3.2 GHz	4.6 GHz	12 MB	65 W	DDR4-2666	Yes	UHD 630 (1.2 GHz)
	10500	6/12	3.1 GHz	4.5 GHz	12 MB	65 W	DDR4-2666	Yes	UHD 630 (1.15 GHz)
	10500T	6/12	2.3 GHz	3.8 GHz	12 MB	35 W	DDR4-2666	Yes	UHD 630 (1.1 GHz)
	10400	6/12	2.9 GHz	4.3 GHz	12 MB	65 W	DDR4-2666	–	UHD 630 (1.1 GHz)
	10400F	6/12	2.9 GHz	4.3 GHz	12 MB	65 W	DDR4-2666	–	None
	10400T	6/12	2.0 GHz	3.6 GHz	12 MB	35 W	DDR4-2666	–	UHD 630 (1.1 GHz)
Core™ i3	10325	4/8	3.9 GHz	4.7 GHz	8 MB	65 W	DDR4-2666	–	UHD 630 (1.15 GHz)
	10320	4/8	3.8 GHz	4.6 GHz	8 MB	65 W	DDR4-2666	–	UHD 630 (1.15 GHz)
	10305	4/8	3.8 GHz	4.5 GHz	8 MB	65 W	DDR4-2666	–	UHD 630 (1.15 GHz)
	10305T	4/8	3.8 GHz	4.5 GHz	8 MB	65 W	DDR4-2666	–	UHD 630 (1.1 GHz)
	10300	4/8	3.7 GHz	4.4 GHz	8 MB	65 W	DDR4-2666	–	UHD 630 (1.15 GHz)
	10300T	4/8	3.0 GHz	3.9 GHz	8 MB	35 W	DDR4-2666	–	UHD 630 (1.1 GHz)
	10105F	4/8	3.7 GHz	4.4 GHz	6 MB	65 W	DDR4-2666	–	None
	10105	4/8	3.7 GHz	4.4 GHz	6 MB	65 W	DDR4-2666	–	UHD 630 (1.1 GHz)
	10105T	4/8	3.0 GHz	3.9 GHz	6 MB	35 W	DDR4-2666	–	UHD 630 (1.1 GHz)
	10100	4/8	3.6 GHz	4.3 GHz	6 MB	65 W	DDR4-2666	–	UHD 630 (1.1 GHz)
	10100F	4/8	3.6 GHz	4.3 GHz	6 MB	65 W	DDR4-2666	–	None
	10100T	4/8	3.0 GHz	3.8 GHz	6 MB	35 W	DDR4-2666	–	UHD 630 (1.1 GHz)
Pentium® Gold	G6605	2/4	4.3 GHz	–	4 MB	58 W	DDR4-2666	–	UHD 630 (1.1 GHz)
	G6600	2/4	4.2 GHz	–	4 MB	58 W	DDR4-2666	–	UHD 630 (1.1 GHz)
	G6505	2/4	4.2 GHz	–	4 MB	58 W	DDR4-2666	–	UHD 630 (1.1 GHz)
	G6500	2/4	4.1 GHz	–	4 MB	58 W	DDR4-2666	–	UHD 630 (1.1 GHz)
	G6500T	2/4	3.5 GHz	–	4 MB	35 W	DDR4-2666	–	UHD 630 (1.05 GHz)
	G6405	2/4	4.1 GHz	–	4 MB	58 W	DDR4-2666	–	UHD 610 (1.05 GHz)
	G6405T	2/4	3.5 GHz	–	4 MB	35 W	DDR4-2666	–	UHD 610 (1.05 GHz)
	G6400	2/4	4.0 GHz	–	4 MB	58 W	DDR4-2666	–	UHD 610 (1.05 GHz)
	G6400T	2/4	3.4 GHz	–	4 MB	35 W	DDR4-2666	–	UHD 610 (1.05 GHz)

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PROCESSOR	MODEL	CORES/ THREADS	CPU CLOCK	TURBO BOOST CLOCK (2.0)	SMART CACHE	TDP	MEMORY SUPPORT	vPRO/AMT SUPPORT	GRAPHICS ENGINE
Celeron®	G5925	2/2	3.6 GHz	–	4 MB	58 W	DDR4-2666	–	UHD 610 (1.05 GHz)
	G5920	2/2	3.5 GHz	–	2 MB	58 W	DDR4-2666	–	UHD 610 (1.05 GHz)
	G5905	2/2	3.5 GHz	–	4 MB	58 W	DDR4-2666	–	UHD 610 (1.05 GHz)
	G5905T	2/2	3.3 GHz	–	4 MB	35 W	DDR4-2666	–	UHD 610 (1.05 GHz)
	G5900	2/2	3.4 GHz	–	2 MB	58 W	DDR4-2666	–	UHD 610 (1.05 GHz)
	G5900T	2/2	3.2 GHz	–	2 MB	35 W	DDR4-2666	–	UHD 610 (1.05 GHz)

K = unlocked, T = Power optimized lifestyle, F = without integrated graphics, TDP = Thermal Design Power (max. Power Consumption).
Note: The Shuttle XPC cube Barebone SW580R8 does not support the Unlock-function of Intel K-Series processors.
Intel processors without integrated graphics can be identified by their model name ending on "F". When using this CPU, a graphics card is required.
Please refer to the support list for detailed processor support information at global.shuttle.com.

11TH GENERATION INTEL CORE DESKTOP PROCESSOR FAMILY

Socket LGA1200 14 nm "Rocket Lake S" processor overview (Date: November 2021)

PROCESSOR	MODEL	CORES/ THREADS	CPU CLOCK	TURBO BOOST CLOCK (2.0)	SMART CACHE	TDP	MEMORY SUPPORT	vPRO/AMT SUPPORT	GRAPHICS ENGINE MAX. CLOCK
Core™ i9	11900K	8/16	3.5 GHz	5.3 GHz	16 MB	125 W	DDR4-3200	Yes	UHD 750 (1.3 GHz)
	11900KF	8/16	3.5 GHz	5.3 GHz	16 MB	125 W	DDR4-3200	–	**None**
	11900	8/16	2.5 GHz	5.2 GHz	16 MB	65 W	DDR4-3200	Yes	UHD 750 (1.3 GHz)
	11900F	8/16	2.5 GHz	5.2 GHz	16 MB	65 W	DDR4-3200	–	**None**
	11900T	8/16	1.5 GHz	4.9 GHz	16 MB	35 W	DDR4-3200	Yes	UHD 750 (1.3 GHz)
Core™ i7	11700K	8/16	3.6 GHz	5.0 GHz	16 MB	125 W	DDR4-3200	Yes	UHD 750 (1.3 GHz)
	11700KF	8/16	3.6 GHz	5.0 GHz	16 MB	125 W	DDR4-3200	–	**None**
	11700	8/16	2.5 GHz	4.9 GHz	16 MB	65 W	DDR4-3200	Yes	UHD 750 (1.3 GHz)
	11700F	8/16	2.5 GHz	4.9 GHz	16 MB	65 W	DDR4-3200	–	**None**
	11700T	8/16	1.4 GHz	4.6 GHz	16 MB	35 W	DDR4-3200	Yes	UHD 750 (1.3 GHz)
Core™ i5	11600K	6/12	3.9 GHz	4.9 GHz	12 MB	125 W	DDR4-3200	Yes	UHD 750 (1.3 GHz)
	11600KF	6/12	3.9 GHz	4.9 GHz	12 MB	125 W	DDR4-3200	–	**None**
	11600	6/12	2.8 GHz	4.8 GHz	12 MB	65 W	DDR4-3200	Yes	UHD 750 (1.3 GHz)
	11600T	6/12	1.7 GHz	4.1 GHz	12 MB	35 W	DDR4-3200	–	UHD 750 (1.3 GHz)
	11500K	6/12	3,9 GHz	4.9 GHz	12 MB	95 W	DDR4-3200	Yes	UHD 750 (1.3 GHz)
	11500	6/12	2.7 GHz	4.6 GHz	12 MB	65 W	DDR4-3200	Yes	UHD 750 (1.3 GHz)
	11500T	6/12	1.5 GHz	3.9 GHz	12 MB	35 W	DDR4-3200	Yes	UHD 750 (1.2 GHz)
	11400	6/12	2.6 GHz	4.4 GHz	12 MB	65 W	DDR4-3200	–	UHD 730 (1.3 GHz)
	11400F	6/12	2.6 GHz	4.4 GHz	12 MB	65 W	DDR4-3200	–	**None**
	11400T	6/12	1.3 GHz	3.7 GHz	12 MB	35 W	DDR4-3200	–	UHD 730 (1.2 GHz)

K = unlocked, T = Power optimized lifestyle, F = without integrated graphics, TDP = Thermal Design Power (max. Power Consumption).
Note: The Shuttle XPC cube Barebone SW580R8 does not support the Unlock-function of Intel K-Series processors.
Intel processors without integrated graphics can be identified by their model name ending on "F". When using this CPU, a graphics card is required.
Please refer to the support list for detailed processor support information at global.shuttle.com.

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10TH GENERATION INTEL XEON W-SERIES PROCESSOR FAMILY

Socket LGA1200 14 nm "Comet Lake" processor overview (Date: November 2021)

PROCESSOR	MODEL	CORES/ THREADS	CPU CLOCK	TURBO BOOST CLOCK (2.0)	SMART CACHE	TDP	MEMORY SUPPORT	vPRO/AMT SUPPORT	GRAPHICS ENGINE MAX. CLOCK
Xeon®	W-1290TE	10	1.8 GHz	4.5 GHz	20 MB	35 W	DDR4-2933 ECC	Yes	HD 630 (1.2 GHz)
	W-1290P	10	3.7 GHz	5.3 GHz	20 MB	125 W	DDR4-2933 ECC	Yes	HD P630 (1.2 GHz)
	W-1290	10	3.2 GHz	5.2 GHz	20 MB	80 W	DDR4-2933 ECC	Yes	HD P630 (1.2 GHz)
	W-1290T	10	1.9 GHz	4.7 GHz	20 MB	35 W	DDR4-2666 ECC	Yes	HD P630 (1.2 GHz)
	W-1290E	10	3.5 GHz	4.8 GHz	20 MB	95 W	DDR4-2933 ECC	Yes	HD 630 (1.2 GHz)
	W-1270	8	3.4 GHz	5.0 GHz	16 MB	80 W	DDR4-2933 ECC	Yes	HD P630 (1.2 GHz)
	W-1270P	8	3.8 GHz	5.1 GHz	16 MB	125 W	DDR4-2933 ECC	Yes	HD P630 (1.2 GHz)
	W-1270E	8	3.4 GHz	4.8 GHz	16 MB	80 W	DDR4-2933 ECC	Yes	HD 630 (1.2 GHz)
	W-1270TE	8	2.0 GHz	4.4 GHz	16 MB	35 W	DDR4-2933 ECC	Yes	HD 630 (1.15 GHz)
	W-1250	6	3.3 GHz	4.7 GHz	12 MB	80 W	DDR4-2666 ECC	Yes	HD P630 (1.2 GHz)
	W-1250P	6	4.1 GHz	4.8 GHz	12 MB	125 W	DDR4-2666 ECC	Yes	HD P630 (1.2 GHz)
	W-1250E	6	3.5 GHz	4.7 GHz	12 MB	80 W	DDR4-2666 ECC	Yes	HD 630 (1.2 GHz)
	W-1250TE	6	2.4 GHz	3.8 GHz	12 MB	35 W	DDR4-2666 ECC	Yes	HD 630 (1.15 GHz)

11TH GENERATION INTEL XEON W-SERIES PROCESSOR FAMILY

Socket LGA1200 14 nm "Rocket Lake" processor overview (Date: November 2021)

PROCESSOR	MODEL	CORES/ THREADS	CPU CLOCK	TURBO BOOST CLOCK (2.0)	SMART CACHE	TDP	MEMORY SUPPORT	vPRO/AMT SUPPORT	GRAPHICS ENGINE MAX. CLOCK
Xeon®	W-1390P	8	3.5 GHz	5.3 GHz	16 MB	125 W	DDR4-3200 ECC	Yes	UHD P750 (1.3 GHz)
	W-1390T	8	1.5 GHz	4.9 GHz	16 MB	35 W	DDR4-3200 ECC	Yes	UHD P750 (1.3 GHz)
	W-1390	8	2.8 GHz	5.2 GHz	16 MB	80 W	DDR4-3200 ECC	Yes	UHD P750 (1.3 GHz)
	W-1370	8	2.9 GHz	5.1 GHz	16 MB	80 W	DDR4-3200 ECC	Yes	UHD P750 (1.3 GHz)
	W-1370P	8	3.6 GHz	5.2 GHz	16 MB	125 W	DDR4-3200 ECC	Yes	UHD P750 (1.3 GHz)
	W-1350P	6	4.0 GHz	5.1 GHz	12 MB	125 W	DDR4-3200 ECC	Yes	UHD P750 (1.3 GHz)
	W-1350	6	3.3 GHz	5.0 GHz	12 MB	80 W	DDR4-3200 ECC	Yes	UHD P750 (1.3 GHz)

Please refer to the support list for detailed processor support information at global.shuttle.com.